



Product Change Notification

Change Notification #: 115077 - 00
Change Title: Intel® Dual Band Wireless-AC 8260
SKUs: 8260.NGWMG; 8260.NGWMG.K;
8260.NGWMG.NV; 8260.NGWMG.NVL;
8260.NGWMG.NVS; 8260.NGWMG.S;
8260.NGWHLG; 8260.NGWHLG.NV,
PCN 115077-00, Transport Media,
Clamshell Update
Date of Publication: November 14, 2016

Key Characteristics of the Change:
Transport Media

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	Dec 02, 2016
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Description of Change to the Customer:

The Intel® Dual Band Wireless-AC 8260 products listed in the products affected table below will undergo the following change:

- Add Korea Recycle Logo to clamshell packaging



Customer Impact of Change and Recommended Action:

The clamshell change does not affect the functionality of the product. Customers should be aware of the changes and take any necessary steps to insure no impact for their receiving and processing of the product in their manufacturing.

Milestone dates are estimates and subject to change based on business and operational conditions.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

Products Affected / Intel Ordering Codes:

Product Code	MM#
8260.NGWHLG	942099
8260.NGWHLG.NV	942102
8260.NGWMG	942165
8260.NGWMG.NV	942167
8260.NGWMG.S	944117
8260.NGWMG.NVS	944118
8260.NGWMG.K	947412
8260.NGWMG.NVL	952147

PCN Revision History:**Date of Revision:**

November 14, 2016

Revision Number:

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Reason:

Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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